



Product Change Notification

Change Notification #: 116273 - 00
Change Title: Intel® Server System R2208WT2YSR, PCN 116273-00, Label, Product Design, Update BSMI Regulatory Mark
Date of Publication: May 22, 2018

Key Characteristics of the Change:

Label, Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	June 18, 2018
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server R2208WT2YSR. These changes are reflected on the Intel® Power Supply AXX1100PCRPS (see pictures below) details are explained on the following points:

1. Add BSMI logo.
2. Change capacitor C829 and resistor R848 to improve Sync-Rec MOSFET
3. Roll up the Product number from G84027-008 to G84027-009

Image - Pre-Change



Image - Post-Change



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2208WT2YSR	943827	J11485-008	J11485-009

PCN Revision History:

Date of Revision:

May 22, 2018

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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